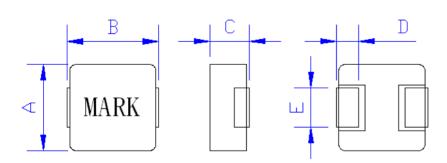
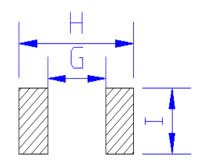


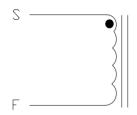
SMD Molding Power Inductor

♦ Dimensions(Unit:mm):





♦ Schematic Diagram:



A	5.20±0.3
В	5.60±0.5
C	1.8 MAX
D	1.30±0.5
E	2.20±0.3
G	1.90 Ref
Н	6.20 Ref
I	2.50 Ref

◆ Electrical Chapacteristics:

Part NO.		Accuracy Grade	* Fremmencv	Test Voltage (mV)	Rdc (mΩ)		Idc (A)		Isat (A)	
					Тур	Max	Max	Тур	Max	Тур
SLO0518HR47MTT	0.47	±20%	100	1000	10.0	12.0	9.0	9.5	11.0	12.0
SLO0518HR68MTT	0.68	±20%	100	1000	12.0	13.5	8.5	9.0	12.5	13.2
SLO0518H1R0MTT	1.0	±20%	100	1000	17.0	20.0	6.5	7.0	7.5	8.0
SLO0518H1R5MTT	1.5	±20%	100	1000	28.0	34.0	5.0	5.2	7.0	7.5
SLO0518H2R2MTT	2.2	±20%	100	1000	34.0	42.0	4.6	4.8	6.5	7.0



SLO0518H Series

Part NO.	Inductance (µH)	Accuracy Grade Test Frequen (KHz	Frequency	Test Voltage (mV)	Rdc (mΩ)		Idc (A)		Isat (A)	
			(KHZ)		Тур	Max	Max	Тур	Max	Тур
SLO0518H3R3MTT	3.3	±20%	100	1000	76.0	84.0	2.8	3.0	4.5	5.0
SLO0518H4R7MTT	4.7	±20%	100	1000	84.0	92.0	2.6	2.8	4.0	4.5
SLO0518H5R6MTT	5.6	±20%	100	1000	95.0	105.0	2.5	2.7	3.8	4.0
SLO0518H6R8MTT	6.8	±20%	100	1000	148.0	163.0	1.9	2.1	3.5	3.8
SLO0518H100MTT	10	±20%	100	1000	165.0	182.0	1.8	2.0	3.0	3.5

×

1:Test conditions: All tests were conducted at room temperature $25\pm2^{\circ}$ C

2:Rated current: At room temperature 25°C, after loading the current, the surface temperature of the product rises by about 40°C (no more than 40°C)

3:Saturation current: At room temperature 25°C, after loading the current, the inductance value drops to 70% of the initial inductance value (no less than 70%).

4:Operating temperature range: $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ (including product surface temperature rise).

In the extreme use environment, the highest temperature that the product can withstand (including product surface temperature rise) does not exceed 125°C. Circuit design, component placement, PCB size and thickness, heat dissipation device and operating frequency will affect the product temperature, please verify the actual temperature of the product in the application.

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SLO0518H Series

◆ Reliability Testing Items

Items	Specifications	Test Method/Condition						
Electrical Performance Test								
L	Refer to standard electrical characteristic list.	Microtest 6377						
Rdc	Refer to standard electrical characteristic list.	TH 2511						
Ide	Refer to standard electrical characteristic list.	Applied the current to coils the inductance change should not be less than 30% to initial value and temperature rise should not be 40°C typical.						
Temperature rise test	The temperature rise does not exceed 40° C.	Applied the rated current for 4 hours.						
Overload test	No evidence of electrical damage	Applied 1.5 times of rated current for a period of 5 minutes						
Climatic Test								
Operating temperature range	-45°C ~+125°C	Includes product surface temperature rise						
High temperature resistance	No mechanical damage. Inductance should not change more than $\pm 10\%$	$+125^{\circ}\text{C} \pm 2^{\circ}\text{C} / 1000\text{h}$ Test at room temperature for 1 hour.						
Low temperature resistance	No mechanical damage. Inductance should not change more than $\pm 10\%$	$-45^{\circ}\text{C} \pm 2^{\circ}\text{C} / 1000\text{h}$. Test at room temperature for 1 hour.						
Temperature shock	No mechanical damage. Inductance should not change more than $\pm 10\%$	Temperature: -45° C for 30 ± 3 min +125°C for 30 ± 3 min Number of cycles: 1000						
Static humidity	No mechanical damage. Inductance should not change more than $\pm 10\%$	Humidity: 85% RH Temperature: $85\% \pm 2\%$ Testing time: $1000 \pm 2h$						



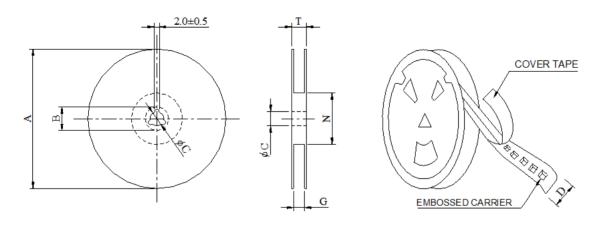
SLO0518H Series

Item	Specifications	Test Method/Condition							
Mechanical performance test									
Solder ability test	At least 95% of terminal electrode should be covered with solder.	Preheating temperature: 150 °C Preheating time: 120s Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Solder temperature: 255 ± 5 °C Duration: 10s Max Solder temperature: 255 ± 5 °C Solder temp							
Resistance to soldering	At least 95% of terminal electrode should be covered with solder. No mechanical damage. Inductance should not change more than $\pm 10\%$	Repeat the reflow curve twice.							
Vibration test	No mechanical damage. Inductance should not change more than $\pm 10\%$	Amplitude modulation: 1.5mm Test time: A period of 2h in each of 3 mutually perpendicular directions. Frequency range: 10Hz to 55Hz to 10Hz for 1min							
Shock test	No mechanical damage. Inductance should not change more than $\pm 10\%$	Duration: 6ms Peak acceleration: 100g Direction: ±X ±Y ±Z (6 directions) Number of shocks: Three consecutive shocks in each direction (total 18 times)							
Adhesion of electrode	No mechanical damage Inductance should not change more than $\pm 10\%$	A 17.7N(1.8kg) force is applied to the side of the inductance for 60(±1)s							
Circuit board bending test	No mechanical damage. Inductance should not change more than $\pm 10\%$.	Apply a force to bend the circuit board at least $(D)x=2mm$, and the duration of the applied force should be $60(\pm 5)s$.							





◆PACKAGING:(Unit:mm)



Part NO.	A	В	C	D	G	N	T	Reel
SLO0518H Series	330	21	13	24	25	100	28	3000Pcs

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